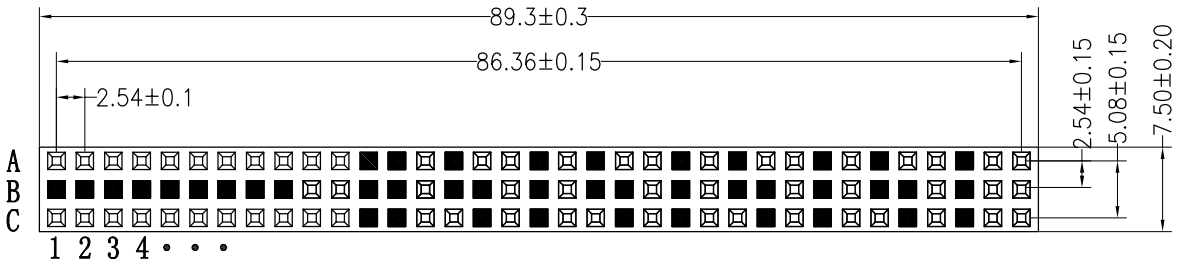
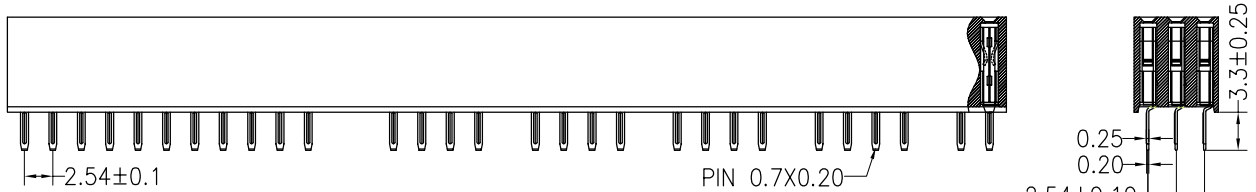
HSF RoHS FILE NO :E362810

SPECIFICATIONS
Rated Current:3.0AMP
Contact Resistance:20mΩ Max
Withstand Voltage:1000V AC/DC
Insulation Resistance:1000MΩ Min
Operation Temperature:−40°c to +105°c

Contact Material:Phosphor Bronze (C5210H)
Contact Plating:Au Over Ni
Insulator Material:Polyester(UL94V−0)
Standard: PA6T
Max.Processing Temp: 230°C for 30−60 seconds
(260°C for 10 seconds)



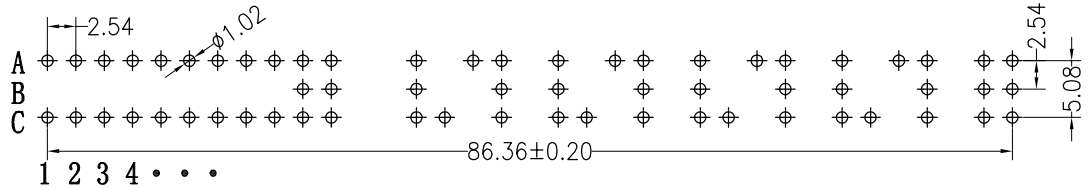
■ 特殊空PIN:A排空12.13.15.18.20.23.25.28.30.33P
B排空1.2.3.4.5.6.7.8.9.12.13.15.16.18.20.21.23.25.26.28.30.31.33P
C排空12.13.16.18.21.23.26.28.31.33P



Ordering Information

2285 03 35 X N XX S O X 01

- 35: No.of Pins Per Row 1−40
- X: Insulator Material Option
  - C=BK−PA6T
  - E=BK−PA9T
  - F=BK−LCP
- XX: Contact Plating
  - G1:1U" Gold
  - G2:1.5U" Gold
  - G3:2U" Gold
  - G4:3U" Gold
  - G5:5U" Gold
  - G6:10U" Gold
  - G7:15U" Gold
  - S0:Gold Flash/Tin
  - SN:Tin
- X: Packing
  - A=Tray
  - T=Tube



Recommended P.C.B Layout(Top Side) (PCB BOARD TOLERANCE±0.05)

REV	DATE	MODIFICATION DESCRIPTION	CHANGE
A	2018.01.16	NEW DRAWING	

OPERATION		DRAW	Liu Miao	18.01.16	SCALE	FIT
X.X	±0.30				UNIT	mm
X.XX	±0.20	CHECK			SIZE	A4
X.XXX	±0.10				SHEET	1/1
Angle	±3°	APPROVE			PROJ.	
DIM	TOL					

WFD CONN 深圳市旺富达电子有限公司
SHEN ZHEN WFD ELECTRONICS CO., LTD

PART NO.	22850335XNXXSOX01
TITLE:	2.54PF H8.5mm 3x35pin 180° DIP 四面包满底型